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2013年11月

FAN7361, FAN7362

高侧栅极驱动器

特性

- 浮动通道专为高达 +600 V 的自举运行而设计
- 源 / 灌电流驱动能力典型值为 250 mA/500 mA
- 共模 dv/dt 噪声消除电路
- V_{CC} 和 V_{BS} 供电范围从 10 V 至 20 V
- V_{BS} 欠压锁定功能
- 输出信号与输入信号同相位
- 8-SOP

应用

- PDP 扫描驱动器
- 电机控制
- SMPS
- 电子镇流器

说明

FAN7361/FAN7362 是单片高侧栅极驱动 IC,可以驱动工作电压最高达 +600 V 的 MOSFET 和 IGBT。飞兆的高压工艺和共模噪声消除技术可使高侧驱动器在高 dv/dt 噪声环境下稳定运行。先进的电平转换电路能使高侧栅极驱动器的工作偏置电压达到 V_{S} = -9.8 V(V_{BS} = 15 V 时的典型值)。

UVLO 电路可防止 V_{BS} 低于指定的阈值电压时发生故障。 输出驱动器通常提供 250 mA/500 mA 的源电流 / 灌电 流,适合萤光灯镇流器、 PDP 扫描驱动器和电机控制 等。

8-SOP



订购信息

		工作			
器件编号	封装	温度范围	② Eco 状态	包装方法	
FAN7361M ⁽¹⁾				塑料管	
FAN7361MX ⁽¹⁾	8-SOP	-40°C ~ 125°C	RoHS	卷带和卷盘	
FAN7362M ⁽¹⁾	6-30F	-40 C ~ 125 C	Kuis	塑料管	
FAN7362MX ⁽¹⁾				卷带和卷盘	

注:

1. 这些器件通过了 JESD22A-111 波峰焊测试。



对于飞兆公司的 Eco 状态定义,请访问: http://www.fairchildsemi.com/company/green/rohs_green.html。

典型应用电路

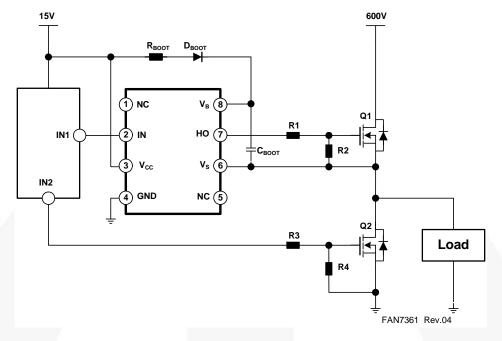


图 1. 典型应用电路

内部框图

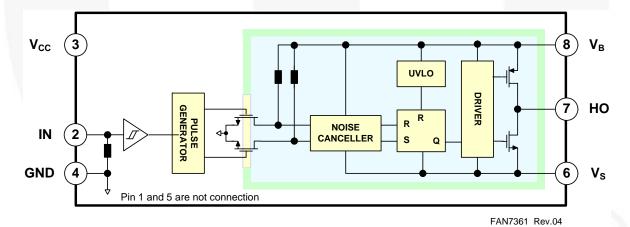


图 2. 功能框图

引脚配置

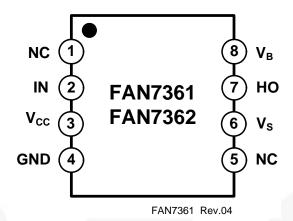


图 3. 引脚配置 (俯视图)

引脚定义

引脚	名称	功能 / 说明
1	NC	无连接
2	IN	高侧栅极驱动器输出的逻辑输入
3	V _{CC}	电源电压
4	GND	逻辑地
5	NC	无连接
6	V _S	高侧浮动电源电压返回
7	НО	高侧驱动输出
8	V _B	高侧浮动电源

绝对最大额定值

应力超过绝对最大额定值,可能会损坏器件。在超出推荐的工作条件的情况下,该器件可能无法正常工作,所以不建议让器件在这些条件下长期工作。此外,长期在高于推荐的工作条件下工作,会影响器件的可靠性。绝对最大额定值仅是应力规格值。除非另有说明, $T_A=25^{\circ}C$ 。

符号	特性	最小值	最大值	单位	
V _S	高侧偏置电压	V _B -25	V _B +0.3		
V _B	高侧浮动电源电压	-0.3	625		
V _{HO}	高侧浮动输出电压	V _S -0.3	V _B +0.3	V	
V _{CC}	固定逻辑电源电压	-0.3	25		
V _{IN}	逻辑输入电压	-0.3	V _{CC} +0.3		
dV _S /dt	允许的偏置电压变化速率		± 50	V/ns	
P _D ⁽²⁾⁽³⁾⁽⁴⁾	功耗		0.625	W	
θ_{JA}	结至环境热阻		200	°C/W	
T_J	结温		+150	°C	
T _S	存储温度		+150	°C	
T _A	环境温度	-40	+125	°C	

注意:

- 2. 安装到 76.2 x 114.3 x 1.6 mm PCB 板 (FR-4 环氧玻璃材料)。
- 3. 参考以下标准:

JESD51-2: 集成电路热测试方法环境条件 - 自然对流 JESD51-3: 含铅表面贴装封装的低有效导热系数测试板

4. 在任何情况下,都不要超过 P_D。

推荐工作条件

推荐的操作条件表明确了器件的真实工作条件。指定推荐的工作条件,以确保器件的最佳性能达到数据表中的规格。 飞兆半导体建议不要超过推荐工作条件,也不能按照绝对最大额定值进行设计。

符号	参数	最小值	最大值	单位
V_{B}	高侧浮动电源电压	V _S +10	V _S +20	
V _S	高侧浮动电源偏置电压	6-V _{CC}	600	7.
V_{HO}	高侧输出电压	V _S	V_{B}	V
V_{IN}	逻辑输入电压	GND	V _{CC}	
V _{CC}	逻辑电源电压	10	20	177

电气特性

除非另有说明, $V_{BIAS}(V_{CC}, V_{BS})=15.0V$ 、 $T_A=25^{\circ}C$ 。 V_{IN} 和 I_{IN} 参数以 GND 作为基准。 V_O 和 I_O 参数以 V_S 作为基 准,适用于相应的输出 HO。

符号	特性	测试	大条件 【条件	最小值	典型值	最大值	单位
V	7. 电源分压工点调炼	\/ +¬+#	FAN7361	8.2	9.2	10.2	
V _{BSUV} +	V _{BS} 电源欠压正向阀值	V _{BS} = 扫描	FAN7362	7.6	8.6	9.6	
V	V. 电源有压存点调体	\/ +¬++	FAN7361	7.4	8.6	9.2	V
V _{BSUV} -	V _{BS} 电源欠压负向阀值	V _{BS} = 扫描	FAN7362	7.2	8.2	9.2	V
V	V _{BS} 电源欠压锁定滞回电压回差	\/ + 7+#	FAN7361		0.5		
V _{BSHYS}		V _{BS} = 扫描	FAN7362		0.4		
I _{LK}	偏置电源漏电流	V _B =V _S =600V				10	
I _{QBS}	V _{BS} 静态电源电流	V _{IN} = 0 V 或 5 V	1		50	80	
I _{QCC}	V _{CC} 静态电源电流	V _{IN} =0V			30	75	μA
I _{PBS}	V _{BS} 工作电源电流	C _L =1nF, f=10kF	-lz		420	550	
V)mtg ((4)) th > 1 c		FAN7361	3.6			
V _{IH}	逻辑 "1" 输入电压		FAN7362	2.9			
\/	Imte (out to) to E		FAN7361			1.0	V
V_{IL}	逻辑 "0" 输入电压		FAN7362			0.8	V
V _{OH}	高电平输出电压, V _B -V _{HO}	无负载	1			0.1	
V _{OL}	低电平输出电压, V _{HO}	无负载				0.1	
I _{IN+}	逻辑 "1" 输入偏置电流	V _{IN} =5V			50	90	^
I _{IN-}	逻辑 "0" 输入偏置电流	V _{IN} =0V			1.0	2.0	μA
I _{O+}	输出高电平短路脉冲电流	V_{HO} = 0 V, V_{IN} = 5 V, PW £ 10 μ s		200	250		mA
I _{O-}	输出低电平短路脉冲电流	V _{HO} =15V, V _{IN} =0V,PW £ 10μs		400	500		
V _S	IN 信号传播到 HO 时允许的 V _S 引脚负电压				-9.8	-7.0	V

动态电气特性

除非另有说明, $V_{BIAS}(V_{CC}, V_{BS})=15.0V, V_{S}=GND, C_{L}=1000pF 且 T_{A}=25$ °C。

符号	特性	测试条件	最小值	典型值	最大值	单位
t _{on}	导通传播延时	V _S =0V		120	200	
t _{off}	关断传播延时	V _S = 0 V 或 600 V		90	180	ns
t _r	导通上升时间			70	160	113
t _f	关断下降时间			30	100	3 \

5. 参数由设计者提供。

典型特性

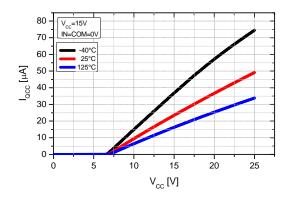


图 4. I_{QCC} 与电源电压的关系

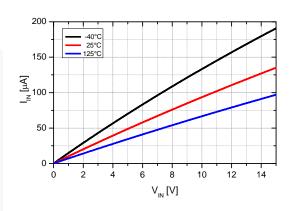


图 5. 输入偏置电流与输入电压的关系

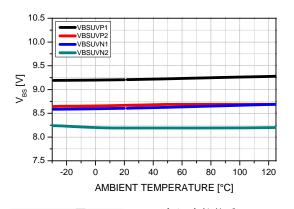


图 6. V_{BS} UVLO 与温度的关系

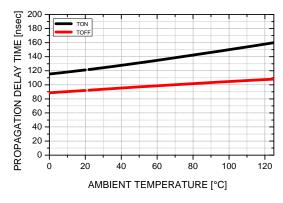


图 7. 导通 / 关断传播时间与温度的关系

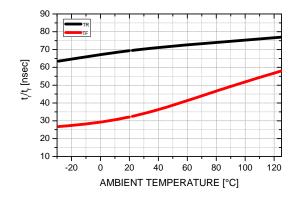


图 8. 上升 / 下降时间与温度的关系

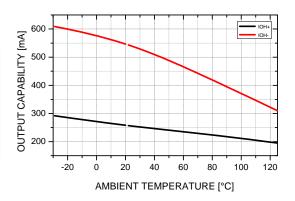


图 9. 输出灌电流/源电流与温度的关系

开关时间定义

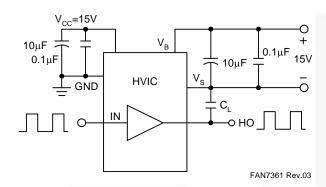


图 10. 开关时间测试电路

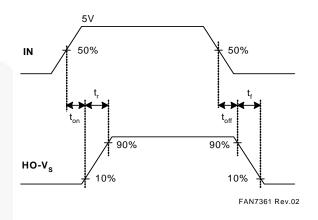
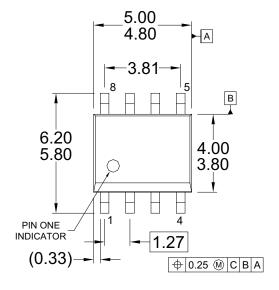
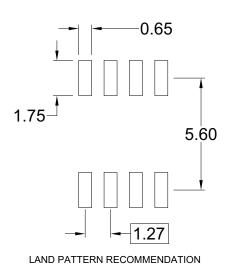
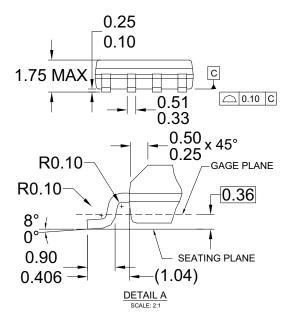


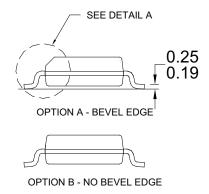
图 11. 输入/输出时序图

物理尺寸









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- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M
- E) DRAWING FILENAME: M08AREV13

图 12.8-引脚小尺寸封装 (SOP)

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